Ultra-Small SPST Analog Switch

The NL7WB66 is a very low RON dual SPST analog switch. RON is a of 5 Ω (Typ) at 5.0 V. The device is offered in the very popular low cost US8 package. It is designed as a general purpose dual switch and can be used to switch either analog signals such as audio and video or digital signal such as TTL, CMOS, LVDS, ECL, or complex digital signals such as QPSK.

Features

- Excellent Performance RDS_{ON} $< 5 \Omega$ at 5.0 V
- Matching between the Switches $\pm 1.0 \Omega$
- 1.65 to 5.5 V Operating Range
- Reduced Threshold Voltages for LVTTL on Control Pine
 - Eliminates the Need for Translators for Many Applications
 - ◆ TTL Compatibility when V_{CC} is 5.0 V
 - ◆ Can Operate with 1.8 V Inputs, if V_{CC} is 3.0
 - Also Meets Full CMOS Specifications
- Ultra-low charge Injection ≤ 7.5 PC
- Low Stand-by Power I_{CC} = 1 nA (Max) at TA = 25°C
- Control Pins IN1, IN2, are Over Voltage Tollerant
- Pin for Pin replacement TC7WB66, NC7WB66, 74LVC2G56

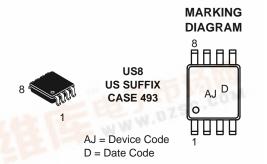
Typical Applications

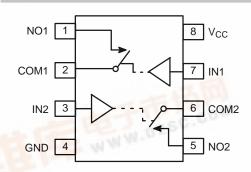
- Cell Phones
- PDAs
- Digital Still Cameras
- Video
- Digital Video



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PIN ASSIGNMENT

Pin	Function	OVT
1	NO1	Yes
2	COM1	-
3	IN2	Yes
4	GND	47.00
5	NO2	Yes
6	COM2	_
7	IN1	Yes
8	V _{CC}	-

FUNCTION TABLE

On/Off	State of
Enable Input	Analog Switch
L	Off
H	On

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.



MAXIMUM RATINGS1

Symbol	Rating		Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +7.0	V
VI	DC Input Voltage		-0.5 to +7.0	V
Vo	DC Output Voltage		-0.5 to +7.0	V
I _{IK}	DC Input Diode Current	V _I < GND	-50	mA
I _{OK}	DC Output Diode Current	V _O < GND	-50	mA
I _O	DC Output Sink Current		±50	mA
I _{CC}	DC Supply Current per Supply Pin		±100	mA
I _{GND}	DC Ground Current per Ground Pin		±100	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
TL	Lead Temperature, 1 mm from Case for 10 Seconds		260	°C
TJ	Junction Temperature under Bias		+150	°C
θ_{JA}	Thermal Resistance		250	°C/W
P _D	Power Dissipation in Still Air at 85°C		250	mW
MSL	Moisture Sensitivity		Level 1	-
F _R	Flammability Rating Oxyg	gen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-

RECOMMENDED OPERATING CONDITIONS

Symbol	Characteristics	Min	Max	Unit	
V _{CC}	Positive DC Supply Voltage	1.65	5.5	V	
V _{IN}	Digital Input Voltage (Enable)	GND	5.5	V	
V _{IO}	Static or Dynamic Voltage Across an Off Switch	GND	V _{CC}	V	
V _{IS}	Analog Input Voltage (NO, COM)	GND	V _{CC}	V	
T _A	Operating Temperature Range, All Package Types	-55	+125	°C	
t _r , t _f	Input Rise or Fall Time (Enable Input)	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ $V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	0	100 20	ns/V

DEVICE JUNCTION TEMPERATURE VS. TIME TO 0.1% BOND FAILURES

Junction Temperature °C	Time, Hours	Time, Years
80	1,032,200	117.8
90	419,300	47.9
100	178,700	20.4
110	79,600	9.4
120	37,000	4.2
130	17,800	2.0
140	8,900	1.0

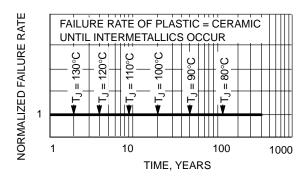


Figure 1. Failure Rate vs. Time Junction Temperature

DC CHARACTERISTICS – Digital Section (Voltages Referenced to GND)

				Guaranteed Max Limit			
Symbol	Parameter	Condition	V _{CC}	25°C	–40 to 85°C	−55 to <125°C	Unit
V _{IH}	High-level Input Voltage, Control Input		1.65 to 1.95 2.3 to 2.7 3.0 to 3.6 4.5 to 5.5	V _{CC} x 0.65 V _{CC} x 0.7 V _{CC} x 0.7 V _{CC} x 0.7	V _{CC} x 0.65 V _{CC} x 0.7 V _{CC} x 0.7 V _{CC} x 0.7	V _{CC} x 0.65 V _{CC} x 0.7 V _{CC} x 0.7 V _{CC} x 0.7	V
V _{IL}	Low-level Input Voltage, Control Input		1.65 to 1.95 2.3 to 2.7 3.0 to 3.6 4.5 to 5.5	V _{CC} x 0.35 V _{CC} x 0.3 V _{CC} x 0.3 V _{CC} x 0.3	V _{CC} x 0.35 V _{CC} x 0.3 V _{CC} x 0.3 V _{CC} x 0.3	V _{CC} x 0.35 V _{CC} x 0.3 V _{CC} x 0.3 V _{CC} x 0.3	٧
I _{IN}	Maximum Input Leakage Current, Enable Inputs	V _{IN} = 5.5 V or GND	0 V to 5.5 V	<u>+</u> 0.1	<u>+</u> 1.0	<u>+</u> 1.0	μΑ
Icc	Maximum Quiescent Supply Current (per package)	Enable and VIS = VCC or GND	5.5	1.0	1.0	2.0	μΑ

DC ELECTRICAL CHARACTERISTICS - Analog Section

				Guaranteed Max Limit				
Symbol	Parameter	Condition		V _{CC}	25°C	–40 to 85°C	−55 to <125°C	Unit
R _{ON}	On–State Switch Resistance	$V_{IS} = V_{CC}$ or GND, $V_{IN} = V_{IH}$	$I_S = 4 \text{ mA}$ $I_S = 8 \text{ mA}$ $I_S = 24 \text{ mA}$ $I_S = 32 \text{ mA}$	1.65 2.3 3.0 4.5	30 20 15 10	30 20 15 10	30 20 15 10	Ω
R _{ON(p)}	Peak On–State Resistance	$V_{IS} = V_{CC}$ or GND, $V_{IN} = V_{IH}$	$I_S = 4 \text{ mA}$ $I_S = 8 \text{ mA}$ $I_S = 24 \text{ mA}$ $I_S = 32 \text{ mA}$	1.65 2.3 3.0 4.5	120 30 20 15	120 30 20 15	120 30 20 15	Ω
ΔR _{ON}	Difference of On–State Resistance between Switches	$V_{IS} = V_{CC}$ or GND, $V_{IN} = V_{IH}$	$I_S = 4 \text{ mA}$ $I_S = 8 \text{ mA}$ $I_S = 24 \text{ mA}$ $I_S = 32 \text{ mA}$	1.65 2.3 3.0 4.5	7.0 5.0 3.0 2.0	7.0 5.0 3.0 2.0	7.0 5.0 3.0 2.0	Ω
I _{NO(OFF)}	Off Leakage Current	$\begin{aligned} & V_{\text{IN}} = V_{\text{IL}} \\ V_{\text{NO}} = 1.0 \text{ V, } V_{\text{COM}} = 4.5 \text{ V or} \\ V_{\text{COM}} = 1.0 \text{ V and } V_{\text{NO}} \ 4.5 \text{ V} \end{aligned}$		5.5	1.0	10	100	nA
I _{COM(OFF)}	Off Leakage Current	$V_{IN} = V_{IL}$ $V_{NO} = 4.5 \text{ V or } 1.0 \text{ V}$ $V_{COM} = 1.0 \text{ V or } 4.5 \text{ V}$		5.5	1.0	10	100	nA

AC ELECTRICAL CHARACTERISTICS (Input t_f = t_f = 3.0 ns)

				Guaranteed Max Limit							
			V _{CC} = 1.8 V ± 0.15 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 5.0 V ± 0.5 V		
Symbol	Parameter	Test Conditions	Min	Max	Min	Max	Min	Max	Min	Max	Unit
t _{ON}			2.3	10	1.6	5.6	1.5	4.4	1.3	3.9	ns
t _{OFF}			2.5	10.5	1.2	6.9	2.0	7.2	1.1	6.3	ns

		Typical @ 25°C, V _{CC} = 5.0 V	Unit
C _{IN}	Maximum Input Capacitance, Select Input	3.0	pF
C _{NO1} or C _{NO2}	Analog I/O (Switch Off)	10	
C _{COM(OFF)}	Common I/O (Switch Off)	10	
C _{COM(ON)}	Feed-through (Switch Off)	10	

ADDITIONAL APPLICATIONS CHARACTERISTICS (Voltage Reference to GND Unless Noted)

Symbol	Parameter	Condition	V _{CC} (V)	Typical 25°C	Unit
BW	Maximum On–Channel –3.0 dB Bandwidth or Minimum Frequency Response	V_{IS} = 0 dBm V_{IS} centered between V_{CC} and GND	2.0 3.0 4.5	102 180 186	MHz
V _{ONL}	Maximum Feed-Through On Loss	V_{IS} = 0 dBm @ 10 kHz V_{IS} centered between V_{CC} and GND	2.0 3.0 4.5	-2.2 -0.8 -0.4	dB
V _{ISO}	Off-Channel Isolation	$f = 100 \text{ kHz}$ $V_{IS} = 1.0 \text{ V RMS}$ $V_{IS} \text{ centered between } V_{CC} \text{ and GND}$	2.0 3.0 4.5	-73 -74 -75	dB
Q	Charge Injection Enable Input to Common I/O	$V_{IS} = V_{CC}$ to GND, $F_{IS} = 20$ kHz $t_r = t_f = 3.0$ nS $R_{IS} = 0$ Ω , $C_L = 100$ pF	3.0 5.5	48 85	pC
THD	Total Harmonic Distortion TDH + Noise	$F_{IS} = 10 \text{ Hz to } 100 \text{ kHz},$ $R_L = Rgen = 600 \Omega, C_L = 50 \text{ pF}$ $V_{IS} = 3.0 \text{ V}_{PP} \text{ Sine Wave}$ $V_{IS} = 5.0 \text{ V}_{PP} \text{ Sine Wave}$	3.0 5.5	0.19 0.06	%

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TIMING INFORMATION

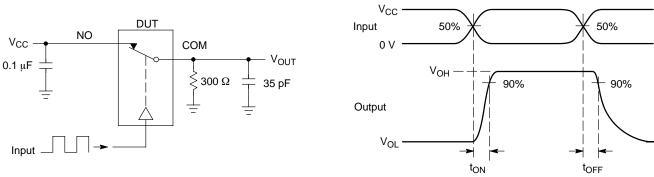


Figure 2. t_{ON}/t_{OFF}

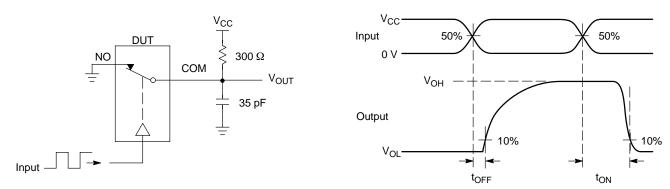
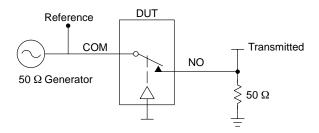


Figure 3. t_{ON}/t_{OFF}



Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch. $V_{\rm ISO}$, Bandwidth and $V_{\rm ONL}$ are independent of the input signal direction.

$$\begin{split} &V_{ISO} = \text{Off Channel Isolation} = 20 \text{ Log } \left(\frac{\text{V}_{OUT}}{\text{V}_{IN}} \right) \text{ for V}_{IN} \text{ at 100 kHz} \\ &V_{ONL} = \text{On Channel Loss} = 20 \text{ Log } \left(\frac{\text{V}_{OUT}}{\text{V}_{IN}} \right) \text{ for V}_{IN} \text{ at 100 kHz to 50 MHz} \end{split}$$

Bandwidth (BW) = the frequency 3 dB below V_{ONL}

Figure 4. Off Channel Isolation/On Channel Loss (BW)/Crosstalk (On Channel to Off Channel)/V_{ONL}

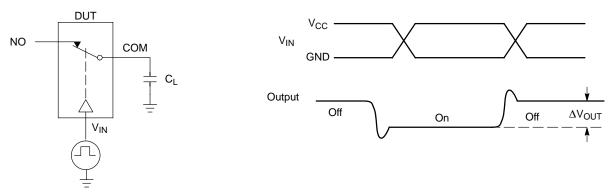


Figure 5. Charge Injection: (Q)

DEVICE ORDERING INFORMATION

		Device Nome	enclature			
Device Order Number	Circuit Indicator	Technology	Device Function	Package Suffix	Package Type	Tape and Reel Size
NL7WB66	NL	AS	2066	US	US8	178 mm (7") 3000 Unit

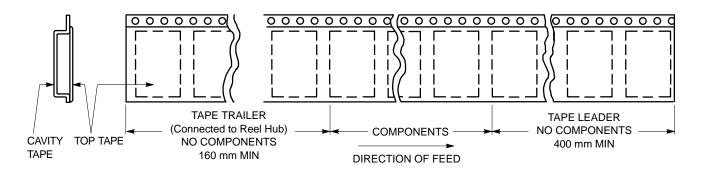


Figure 6. Tape Ends for Finished Goods

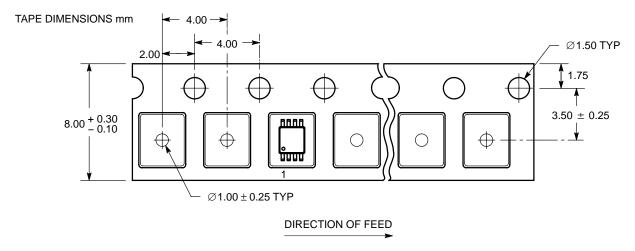


Figure 7. US8 Reel Configuration/Orientation

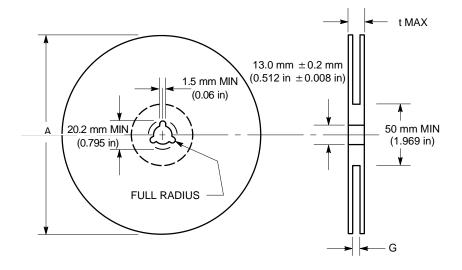


Figure 8. Reel Dimensions

REEL DIMENSIONS

Tape Size	T and R Suffix	A Max	G	t Max
8 mm	US	178 mm (7 in)	8.4 mm, + 1.5 mm, -0.0 (0.33 in + 0.059 in, -0.00)	14.4 mm (0.56 in)

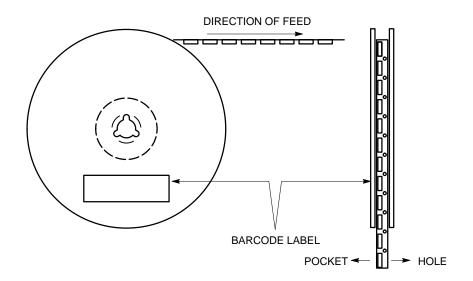
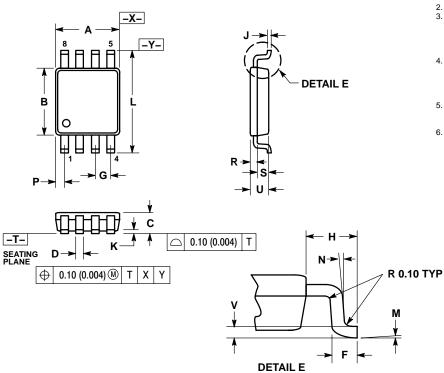


Figure 9. Reel Winding Direction

PACKAGE DIMENSIONS

US8 **US SUFFIX** CASE 493-02 ISSUE A



- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETERS.

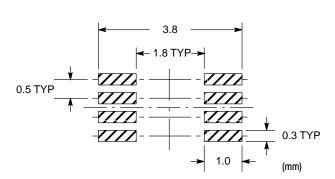
 3. DIMENSION "A" DOES NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURR. MOLD FLASH. PROTRUSION AND GATE BURR SHALL NOT EXCEED 0.140 MM (0.0055") PER SIDE.

 4. DIMENSION "B" DOES NOT INCLUDE INTER-LEAD FLASH AND PROTRUSION. INTER-LEAD FLASH AND PROTRUSION SHALL NOT E3XCEED 0.140 (0.0055") PER SIDE.
- SHALL NOT ESACELD 0.130 (0.0027), SIDE.

 5. LEAD FINISH IS SOLDER PLATING WITH THICKNESS OF 0.0076–0.0203 MM. (300–800 °).

 6. ALL TOLERANCE UNLESS OTHERWISE SPECIFIED ±0.0508 (0.0002 °).

Γ		MILLIMETERS		INCHES	
L	DIM	MIN	MAX	MIN	MAX
	Α	1.90	2.10	0.075	0.083
	В	2.20	2.40	0.087	0.094
	С	0.60	0.90	0.024	0.035
	D	0.17	0.25	0.007	0.010
	F	0.20	0.35	0.008	0.014
	G	0.50 BSC		0.020 BSC	
	Н	0.40 REF		0.016 REF	
	J	0.10	0.18	0.004	0.007
L	K	0.00	0.10	0.000	0.004
L	L	3.00	3.20	0.118	0.126
	М	0°	6 °	0 °	6 °
	N	5°	10 °	5°	10 °
	Р	0.23	0.34	0.010	0.013
	R	0.23	0.33	0.009	0.013
L	S	0.37	0.47	0.015	0.019
	C	0.60	0.80	0.024	0.031
	٧	0.12 BSC		0.005 BSC	



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